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Vishay Siliconix

Automotive P-Channel 60 V (D-S) 175 °C MOSFET

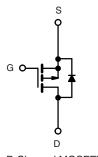


PRODUCT SUMMARY			
V _{DS} (V)	-60		
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0088		
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0163		
I _D (A) ^g	-118		
Configuration	Single		

FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % Rq and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and Halogen-free	SQJ161ELP-T1-GE3

ABSOLUTE MAXIMUM RATINGS	$T_C = 25 ^{\circ}C$, unless	s otherwise noted	l)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	-60	V	
Gate-source voltage ^a		V_{GS}	± 20		
Continuous drain current ^g	T _C = 25 °C b	1	-118		
	T _C = 125 °C	Ι _D	-68		
Continuous source current (diode conduction) b, g		I _S	-223	Α	
Pulsed drain current c, g	ed drain current c, g		-262		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-52		
Single pulse avalanche energy	L = U.1 MH	E _{AS}	135	mJ	
Maximum power dissipation c, g	T _C = 25 °C	D	245	W	
	T _C = 125 °C	P_{D}	82		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) d, e			260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount e	R _{thJA}	42	°C/W	
Junction-to-case (drain) ^f		R_{thJC}	0.61	C/VV	

Notes

- a. Not intended for continuous use with positive gate voltage > 5.0 V
- b. Package limited
- When mounted on 1" square PCB (FR4 material)
- See solder profile (www.vishay.com/doc?73257). For PowerPAK SO-8L, the end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
 Pulse test; pulse width \(\leq 300 \) µs, duty cycle \(\leq 2 \) %

- Using thermal characterization methods based on JESD51-14
 Values based on R_{thJC} and T_C of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static	1					L		
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0, I _D = -250 μA		-60	-	-	.,	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = -250 μA	-1.5	-2.0	-2.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Zero gate voltage drain current		$V_{GS} = 0 V$	V _{DS} = -60 V	-	-	-1		
	I _{DSS}		V _{DS} = -60 V, T _J = 125 °C	1	-	-50	μΑ	
		$V_{GS} = 0 V$	V _{DS} = -60 V, T _J = 175 °C	-	-	-150		
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	V _{DS} ≥ -5 V	-30	-	-	Α	
Drain-source on-state resistance ^a		V _{GS} = -10 V	I _D = -10 A	-	0.0073	0.0088	Ω	
		V _{GS} = -10 V	I _D = -10 A, T _J = 125 °C	-	-	0.0143		
	R _{DS(on)}	V _{GS} = -10 V	I _D = -10 A, T _J = 175 °C	-	-	0.0175		
		V _{GS} = -4.5 V	I _D = -8 A	-	0.0125	0.0163		
Forward transconductance b	9 _{fs}	V _{DS} =	-15 V, I _D = -30 A	-	62	-	S	
Dynamic ^b								
Input capacitance	C _{iss}		V _{DS} = -25 V, f = 1 MHz	-	4140	5796	pF	
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	2176	3047		
Reverse transfer capacitance	C _{rss}			-	93	131		
Total gate charge ^c	Qg			-	61	92		
Gate-source charge c	Q _{gs}	V _{GS} = -10 V	$V_{GS} = -10 \text{ V}$ $V_{DS} = -30 \text{ V}, I_D = -15 \text{ A}$		15	-	nC	
Gate-drain charge ^c	Q_{gd}	7			8	-		
Gate resistance	R _g	f = 1 MHz		0.6	1,6	3,2	Ω	
Turn-on delay time ^c	t _{d(on)}				17	26	ns	
Rise time ^c	t _r	$V_{DD} = -30 \text{ V, } R_L = 3 \Omega,$ $I_D \cong -15 \text{ A, } V_{GEN} = -10 \text{ V, } R_g = 1 \Omega$		-	6	9		
Turn-off delay time ^c	t _{d(off)}			-	39	59		
Fall time ^c	t _f			-	7	11		
Source-Drain Diode Ratings and Chara	acteristics ^b							
Pulsed current ^a	I _{SM}			-	-	-262	Α	
Forward voltage	V _{SD}	I _F = -10 A, V _{GS} = 0 V			-0.76	-1.2	V	
Body diode reverse recovery time	t _{rr}	I _F = -10 A, di/dt = 100 A/μs		-	73	146	ns	
Body diode reverse recovery charge	Q _{rr}			-	105	210	nC	
Reverse recovery fall time	ta			-	38	-	ns	
Reverse recovery rise time	t _b			-	35	-		
Body diode peak reverse recovery current	I _{RM(REC)}			-	-2.4	-	Α	

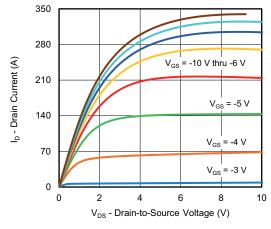
Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

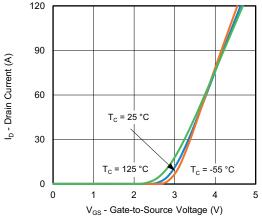
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



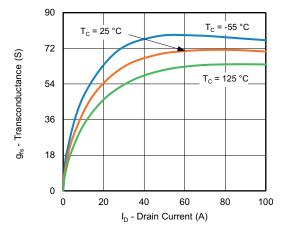
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



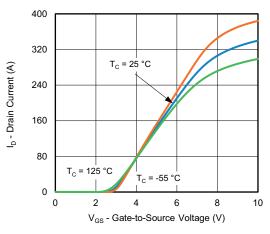
Output Characteristics



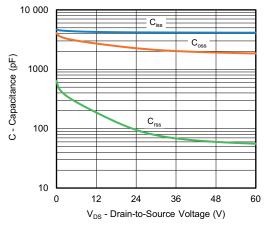
Transfer Characteristics



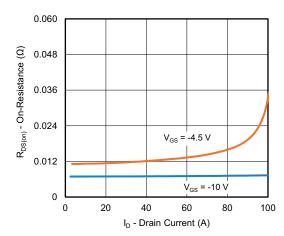
Transconductance



Transfer Characteristics



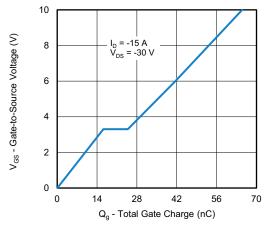
Capacitance



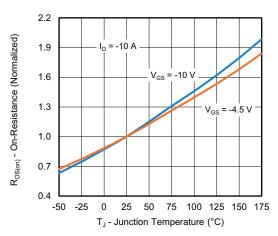
On-Resistance vs. Drain Current



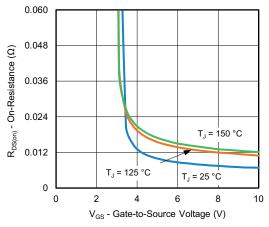
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



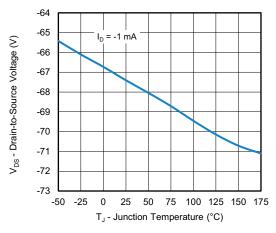




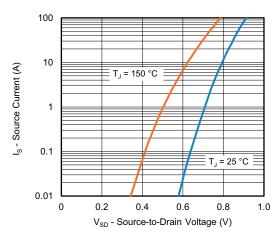
On-Resistance vs. Junction Temperature



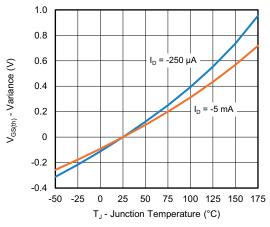
On-Resistance vs. Gate-to-Source Voltage



Drain-Source Breakdown vs. Junction Temperature



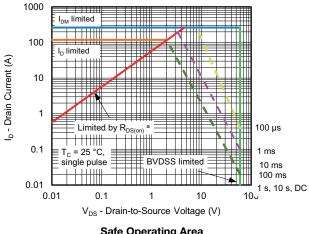
Source Drain Diode Forward Voltage



Threshold Voltage

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

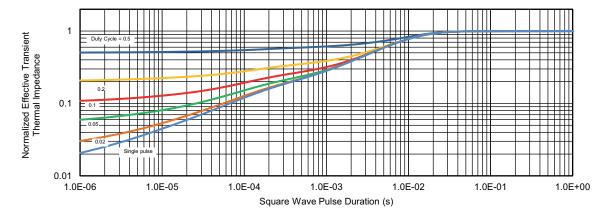


Safe Operating Area

Note

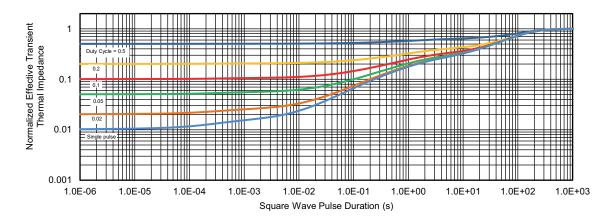
a. $V_{GS} > \mbox{minimum} \ V_{GS}$ at which $R_{DS(on)}$ is specified

THERMAL RATINGS (T_C = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case





Normalized Thermal Transient Impedance, Junction-to-Ambient

Note

- · The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62377.



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